

LVDS Single Port High Speed Repeater

FIN1101

General Description

This single port repeater is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. It accepts and outputs LVDS levels with a typical differential output swing of 330 mV which provides low EMI at ultra low power dissipation even at high frequencies. It can directly accept multiple differential I/O including: LVPECL, HSTL, and SSTL-2 for translating directly to LVDS.

Features

- Up to 1.6 Gb/s Full Differential Path
- 3.5 ps Max Random Jitter and 135 ps Max Deterministic Jitter
- 3.3 V Power Supply Operation
- Wide Rail-To-Rail Common Mode Range
- Ultra Low Power Consumption
- LVDS Receiver Inputs Accept LVPECL, HSTL, and SSTL-2 Directly
- Power Off Protection
- 7 kV HBM ESD Protection (All Pins)
- Meets or Exceed the TA/EIA-644-A LVDS Standard
- Packaged in 8-Pin SOIC and US8
- Open Circuit Fail Safe Protection
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

PIN DESCRIPTIONS

Pin Name	Description
R _{IN+}	Non-Inverting LVDS Inputs
R _{IN-}	Inverting LVDS Inputs
D _{OUT+}	Non-Inverting Driver Outputs
D _{OUT-}	Inverting Driver Outputs
EN	Driver Enable Pin
V _{CC}	Power Supply
GND	Ground

FUNCTION TABLE

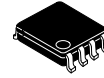
Inputs			Outputs	
EN	R _{IN+}	R _{IN-}	D _{OUT+}	D _{OUT-}
H	H	L	H	L
H	L	H	L	H
H	Fail Safe Case		H	L
L	X	X	Z	Z

H = HIGH Logic Level
X = Don't Care

L = LOW Logic Level
Z = High Impedance

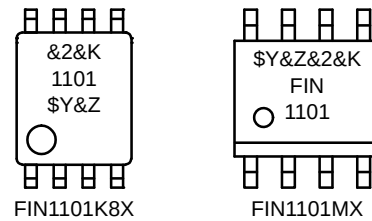


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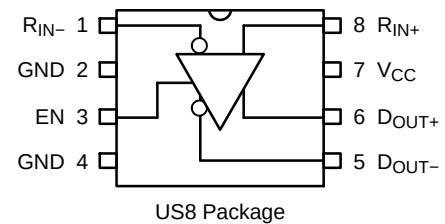
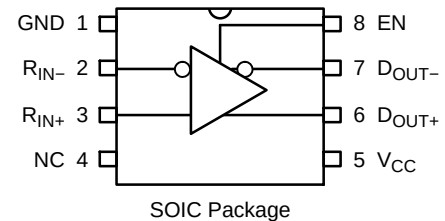
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CASE 846AN

MARKING DIAGRAM

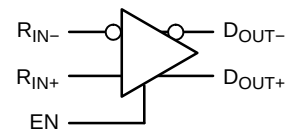


\$Y = Logo
 &Z = Assembly Plant Code
 &2 = 2-Digit Date Code
 &K = 2-Digits Lot Run Traceability Code
 1101, FIN1101 = Specific Device Code

CONNECTION DIAGRAMS



FUNCTIONAL DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	-0.5 V to +4.6 V
V_{IN}	LVDS DC Input Voltage	-0.5 V to +4.6 V
V_{OUT}	LVDS DC Output Voltage	-0.5 V to +4.6 V
I_{OSD}	Driver Short Circuit Current	Continuous 10 mA
T_{STG}	Storage Temperature Range	-65°C to +150°C
T_J	Max Junction Temperature	150°C
T_L	Lead Temperature (Soldering, 10 seconds)	260°C
	ESD (Human Body Model)	7000 V
	ESD (Machine Model)	300 V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value
V_{CC}	Supply Voltage	3.0 V to 3.6 V
T_A	Operating Temperature	-40°C to +85°C
$ V_{ID} $	Magnitude of Input Differential Voltage	100 mV to V_{CC}
V_{IC}	Common Mode Input Voltage	$(0\text{ V} + V_{ID} / 2)$ to $(V_{CC} - V_{ID} / 2)$

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (Over supply voltage and operating temperature ranges, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Typ (Note 1)	Max	Unit
V_{TH}	Differential Input Threshold HIGH	See Figure 1; $V_{IC} = +0.05\text{ V}$, $+1.2\text{ V}$, or $(V_{CC} - 0.05\text{ V})$	-	-	100	mV
V_{TL}	Differential Input Threshold LOW	See Figure 1; $V_{IC} = +0.05\text{ V}$, $+1.2\text{ V}$, or $(V_{CC} - 0.05\text{ V})$	-100	-	-	mV
V_{IH}	Input High Voltage (EN)		2.0	-	V_{CC}	V
V_{IL}	Input Low Voltage (EN)		GND	-	0.8	V
V_{OD}	Output Differential Voltage	$R_L = 100\ \Omega$, Driver Enabled, See Figure 2	250	330	450	mV
ΔV_{OD}	V_{OD} Magnitude Change from Differential LOW-to-HIGH	$R_L = 100\ \Omega$, Driver Enabled, See Figure 2	-	-	25	mV
V_{OS}	Offset Voltage	$R_L = 100\ \Omega$, Driver Enabled, See Figure 2	1.125	1.23	1.375	V
ΔV_{OS}	Offset Magnitude Change from Differential LOW-to-HIGH	$R_L = 100\ \Omega$, Driver Enabled, See Figure 2	-	-	25	mV
I_{OS}	Short Circuit Output Current	$D_{OUT+} = 0\text{ V}$ & $D_{OUT-} = 0\text{ V}$, Driver Enabled	-	-3.4	-6	mA
I_{OS}	Short Circuit Output Current	$V_{OD} = 0\text{ V}$, Driver Enabled	-	± 3.4	± 6	mA
I_{IN}	Input Current (EN, D_{INX+} , D_{INX-})	$V_{IN} = 0\text{ V}$ to V_{CC} . Other Input = V_{CC} or 0 V (for Differential Inputs)	-	-	± 20	μA
I_{OFF}	Power-Off Input or Output Current	$V_{CC} = 0\text{ V}$, V_{IN} or $V_{OUT} = 0\text{ V}$ to 3.6 V	-	-	± 20	μA
I_{CCZ}	Disabled Power Supply Current	Drivers Disabled	-	3.2	5.5	mA
I_{CC}	Power Supply Current	Drivers Enabled, Any Valid Input Condition	-	9.3	13.5	mA
I_{OZ}	Disabled Output Leakage Current	Driver Disabled, $D_{OUT+} = 0\text{ V}$ to 3.6 V or $D_{OUT-} = 0\text{ V}$ to 3.6 V	-	-	± 20	μA
V_{IC}	Common Mode Voltage Range	$ V_{ID} = 100\text{ mV}$ to V_{CC}	$0\text{ V} + V_{ID} / 2$	-	$V_{CC} - (V_{ID} / 2)$	V
C_{IN}	Input Capacitance	EN Input	-	2.2	-	pF
		Data Input	-	2.0	-	pF
C_{OUT}	Output Capacitance		-	2.6	-	pF

1. All typical values are at $T_A = 25^\circ\text{C}$ and with $V_{CC} = 3.3\text{ V}$.

AC ELECTRICAL CHARACTERISTICS (Over supply voltage and operating temperature ranges, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Typ (Note 2)	Max	Unit
t_{PLHD}	Differential Propagation Delay LOW-to-HIGH	$R_L = 100\ \Omega$, $C_L = 5\ \text{pF}$, $V_{ID} = 200\ \text{mV}$ to $450\ \text{mV}$, $V_{IC} = V_{ID} / 2$ to $(V_{CC} - (V_{ID} / 2))$, Duty Cycle = 50%, See Figure 3 and Figure 4	0.75	1.1	1.75	ns
t_{PHLD}	Differential Propagation Delay HIGH-to-LOW		0.75	1.1	1.75	ns
t_{TLHD}	Differential Output Rise Time (20% to 80%)		0.29	0.40	0.58	ns
t_{THLD}	Differential Output Fall Time (80% to 20%)		0.29	0.40	0.58	ns
$t_{SK(P)}$	Pulse Skew $ t_{PLH} - t_{PHL} $		–	0.01	0.2	ns
$t_{SK(PP)}$	Part-to-Part Skew (Note 3)		–	–	0.5	ns
f_{MAX}	Maximum Frequency (Note 4) (Note 5)		400	800	–	MHz
t_{PZH}	Differential Output Enable Time from Z to HIGH	$R_L = 100\ \Omega$, $C_L = 5\ \text{pF}$, See Figure 2 and Figure 3	–	2.1	5	ns
t_{PZH}	Differential Output Enable Time from Z to LOW		–	2.3	5	ns
t_{PHZ}	Differential Output Disable Time from HIGH to Z		–	1.5	5	ns
t_{PLZ}	Differential Output Disable Time from LOW to Z		–	1.8	5	ns
t_{DJ}	LVDS Data Jitter, Deterministic	$V_{ID} = 300\ \text{mV}$, PRBS = $2^{23} - 1$, $V_{IC} = 1.2\ \text{V}$ at 800 Mbps	–	85	135	ps
t_{RJ}	LVDS Clock Jitter, Random (RMS)	$V_{ID} = 300\ \text{mV}$ $V_{IC} = 1.2\ \text{V}$ at 400 MHz	–	2.1	3.5	ps

2. All typical values are at $T_A = 25^\circ\text{C}$ and with $V_{CC} = 3.3\ \text{V}$, $V_{ID} = 300\ \text{mV}$, $V_{IC} = 1.2\ \text{V}$ unless otherwise specified.
3. $t_{SK(PP)}$ is the magnitude of the difference in differential propagation delay times between identical channels of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.
4. Passing criteria for maximum frequency is the output $V_{OD} > 200\ \text{mV}$ and the duty cycle is 45% to 55% with all channels switching.
5. Output loading is transmission line environment only; C_L is $< 1\ \text{pF}$ of stray test fixture capacitance.

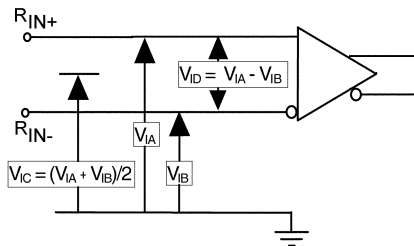


Figure 1. Differential Receiver Voltage Definitions and Propagation I and Transition Time Test Circuit

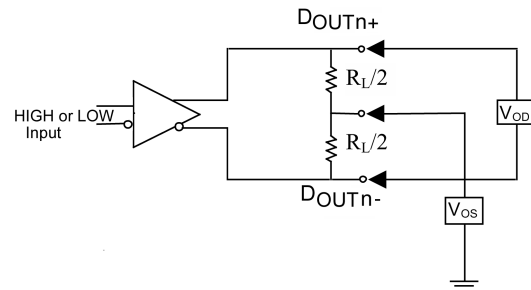
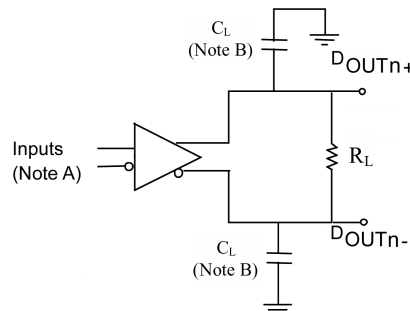


Figure 2. Differential Driver DC Test Circuit



Note A: All LVDS input pulses have frequency = 10 MHz, t_R or $t_F \leq 0.5\ \text{ns}$
 Note B: C_L includes all probe and test fixture capacitances

Figure 3. Differential Driver Propagation Delay and Transition Time Test Circuit

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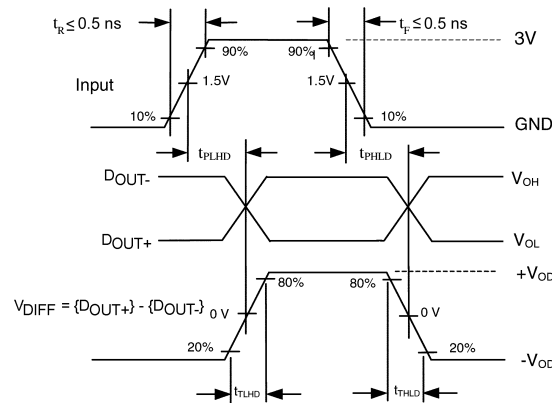
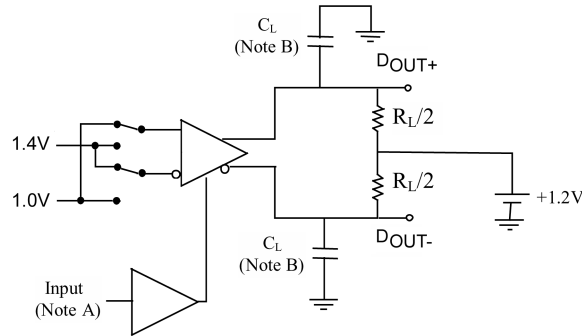


Figure 4. AC Waveforms



Note A: All LVTTTL input pulses have frequency = 10 MHz, t_R or $t_F \leq 2$ ns
Note B: C_L includes all probe and test fixture capacitances

Figure 5. Differential Driver Enable and Disable Test Circuit

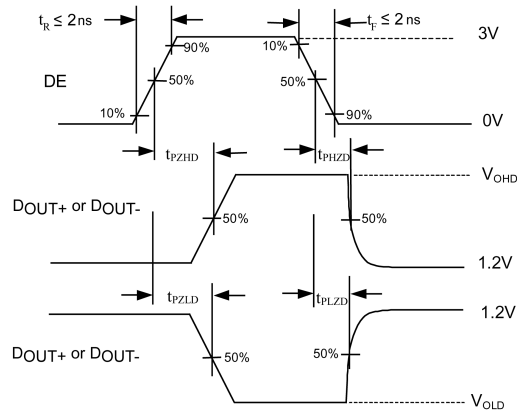


Figure 6. Enable and Disable AC Waveforms

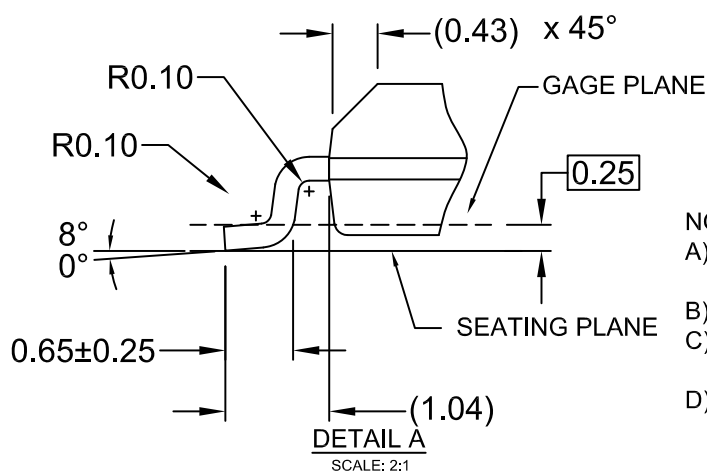
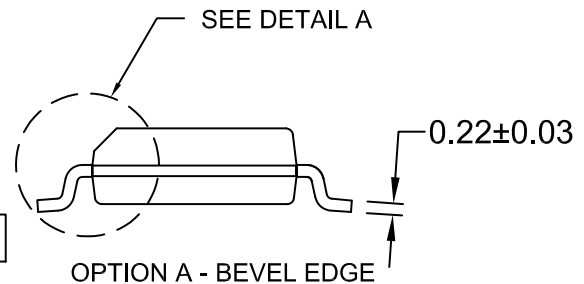
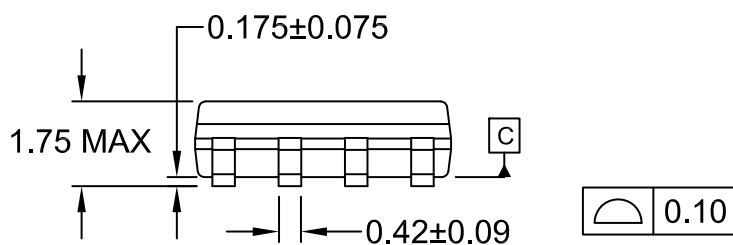
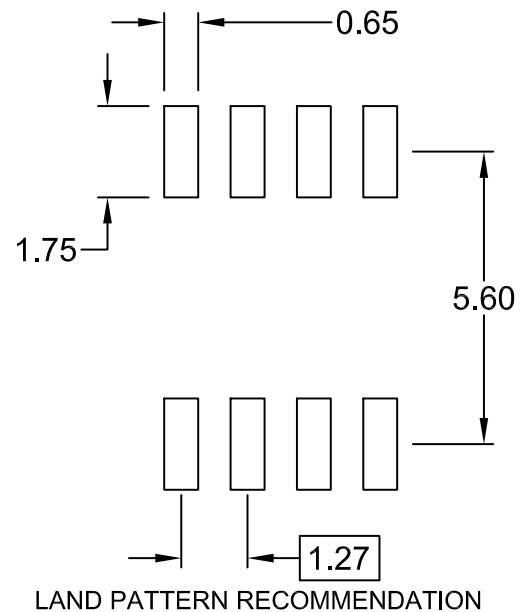
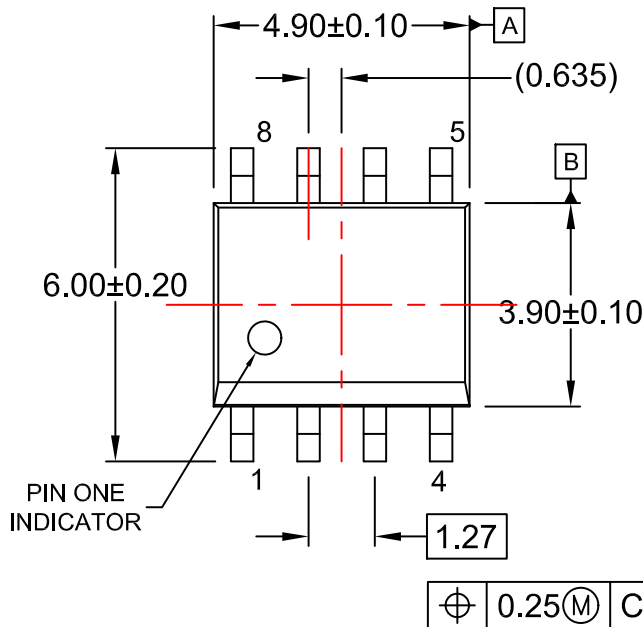
ORDERING INFORMATION

Order Number	Package Number	Package Description	Shipping [†]
FIN1101MX	M08A	8-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow (Pb-Free)	2500 / Tape & Reel
FIN1101K8X	MAB08A	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide (Pb-Free)	3000 / Tape & Reel

[†]For Information On Tape And Reel Specifications, Including Part Orientation And Tape Sizes, Please Refer To Our Tape And Reel Packaging Specifications Brochure, Brd8011/D.

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DATE 24 AUG 2017



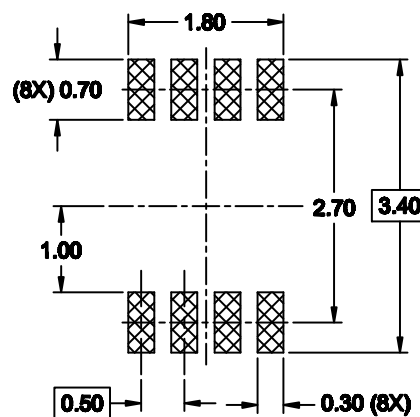
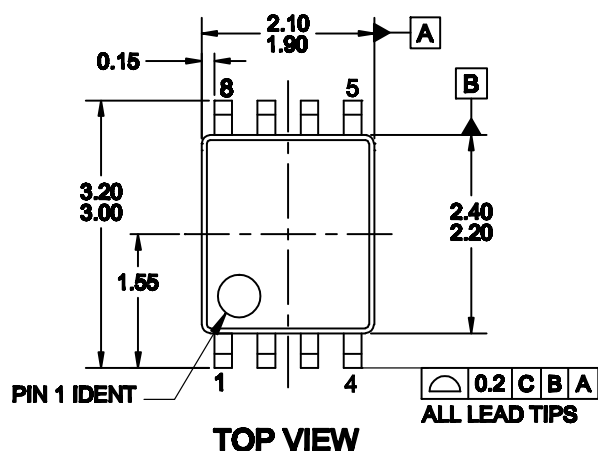
- NOTES:
- A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AA.
 - B) ALL DIMENSIONS ARE IN MILLIMETERS.
 - C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
 - D) LANDPATTERN STANDARD: SOIC127P600X175-8M

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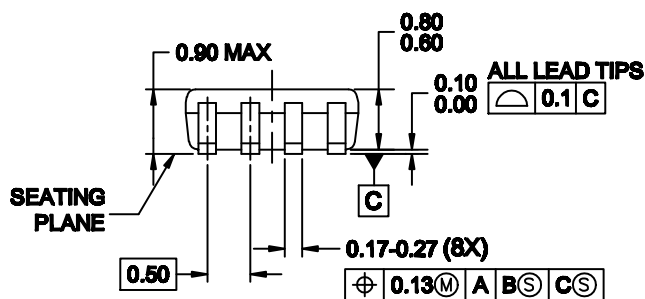
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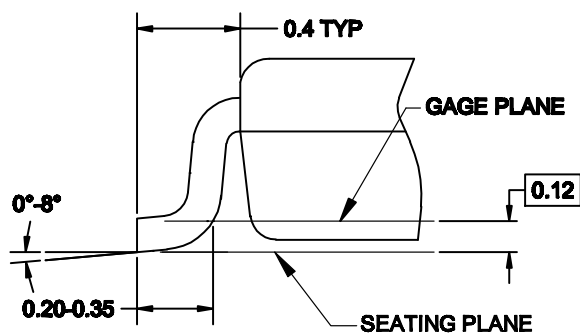
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RECOMMENDED LAND PATTERN



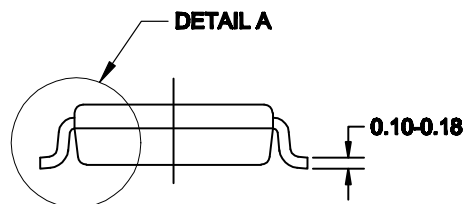
SIDE VIEW



DETAIL A

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187**
- B. DIMENSIONS ARE IN MILLIMETERS.**
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS,
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- D. DIMENSIONS AND TOLERANCES PER
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